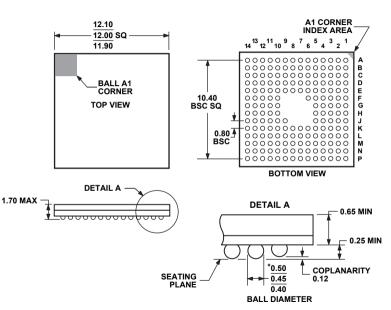


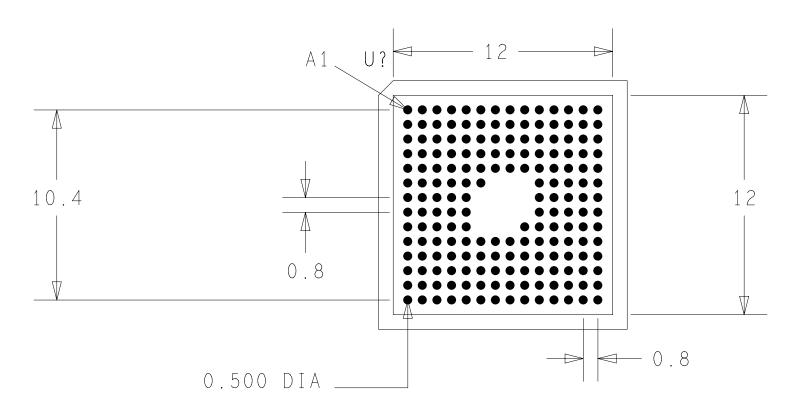
182-Ball Chip Scale Package Ball Grid Array [CSP_BGA] (BC-182)

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-205-AE WITH THE EXCEPTION TO BALL DIAMETER.

Analog Devices BC-182 REV A



(Dim. are in MM)
LAST MODIFIED 09/11/07